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1-26-06 Lillian Garcia
Date Name
Signature

Customer No.: 07278

Docket No.: 09864/0202607-US0

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Takashi Nakai et. al.

Serial No.: 10/531,813

Filed: April 18, 2005

For: METHOD FOR FORMING COMPACT FROM POWDER AND MOLD APPARATUS FOR POWDER MOLDING

REQUEST FOR CORRECTED FILING RECEIPT

Commissioner of Patents and Trademarks
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

1. Attached is a copy of the official filing receipt received from the PTO in the above application for which issuance of a corrected filing receipt is respectfully requested.
2. There is an error with respect to the following data, which is:



incorrectly entered

and/or



omitted.

☐ Applicant's name

☐ Applicant's address

☒ Title

☐ Filing Date

☐ Application Number


☐ Foreign/PCT Application Re:

☐ Other

METHOD FOR FORMING COMPACT FROM POWDER AND MOLD APPARATUS FOR POWDER MOLDING

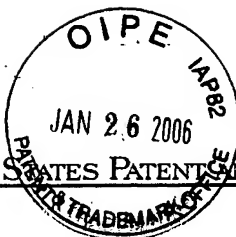
Enclosed please find a copy of the Application Data Sheet.

Respectfully submitted,



Flynn Barrison
Reg. No. 53,970
Agent for Applicant(s)

{W:\09864\0202607us0\00556893.DOC / 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20 21 22 23 24 25 26 27 28 29 30 31 32 33 34 35 36 37 38 39 40 41 42 43 44 45 46 47 48 49 50 51 52 53 54 55 56 57 58 59 60 }



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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/531,813	04/18/2005	1775	900	09864/0202607-US0	3	18	1

CONFIRMATION NO. 3685

CORRECTED FILING RECEIPT



OC000000017862532

7278
 DARBY & DARBY P.C.
 P. O. BOX 5257
 NEW YORK, NY 10150-5257

Date Mailed: 01/18/2006

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

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 Kinya Kawase, Niigata-shi, JAPAN;

Assignment For Published Patent Application

Mitsubishi Materials Corporation, Tokyo, JAPAN

Power of Attorney: The patent practitioners associated with Customer Number 7278.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP03/14643 11/18/2003

Foreign Applications

JAPAN 2002-338621 11/21/2002

If Required, Foreign Filing License Granted: 01/18/2006

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is **US10/531,813**

Projected Publication Date: 02/02/2006

Non-Publication Request: No

Early Publication Request: No

Title

Method for forming compact from powder and mold apparatus for powder forming

Preliminary Class

428

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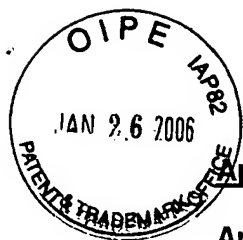
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Application Data Sheet

Application Information

Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	METHOD FOR FORMING COMPACT FROM POWDER AND MOLD APPARATUS FOR POWDER MOLDING (AS AMENDED)
Attorney Docket Number::	09864/0202607-US0
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	Fig. 1
Total Drawing Sheets::	3
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

Applicant Information

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Correspondence Customer Number:: 07278

Representative Information

Representative Customer Number:: 07278

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2003/014643	11/18/03

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2002-338621	11/21/02	No

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